

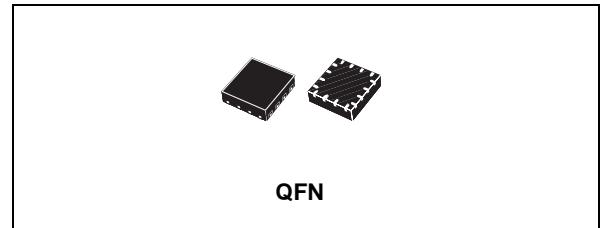
## LOW VOLTAGE 0.5/0.8Ω MAX DUAL SPDT SWITCH WITH BREAK BEFORE MAKE FEATURE

- HIGH SPEED:  
 $t_{PD} = 0.3\text{ns}$  (TYP.) at  $V_{CC} = 3.0\text{V}$   
 $t_{PD} = 0.4\text{ns}$  (TYP.) at  $V_{CC} = 2.3\text{V}$
- ULTRA LOW POWER DISSIPATION:  
 $I_{CC} = 0.2\mu\text{A}$  (MAX.) at  $T_A = 85^\circ\text{C}$
- LOW "ON" RESISTANCE  $V_{IN} = 0\text{V}$ :  
 $R_{ON-S1} = 0.5\Omega$  (MAX.  $T_A = 25^\circ\text{C}$ ) at  $V_{CC}=2.7\text{V}$   
 $R_{ON-S2} = 0.8\Omega$  (MAX.  $T_A = 25^\circ\text{C}$ ) at  $V_{CC}=2.7\text{V}$
- WIDE OPERATING VOLTAGE RANGE:  
 $V_{CC}$  (OPR) = 1.65V to 4.3V SINGLE SUPPLY
- 4.3V TOLERANT AND 1.8V COMPATIBLE THRESHOLD ON DIGITAL CONTROL INPUT at  $V_{CC} = 2.3$  to 3.0V
- LATCH-UP PERFORMANCE EXCEEDS 300mA (JESD 17)
- ESD PERFORM. (ANALOG CHAN. vs GND): HBM > 7KV (MIL STD 883 method 3015)

### DESCRIPTION

The STG3680 is an high-speed CMOS DUAL ANALOG S.P.D.T. (Single Pole Dual Throw) SWITCH or DUAL 2:1 Multiplexer/Demultiplexer Bus Switch fabricated in silicon gate C<sup>2</sup>MOS technology. It is designed to operate from 1.65V to 4.3V, making this device ideal for portable applications.

It offers very low ON-Resistance (<0.5Ω 1S1 and 2S1 channels; <0.8Ω 1S2 and 2S2 channels) at  $V_{CC}=2.7\text{V}$ . The nIN inputs are provided to control

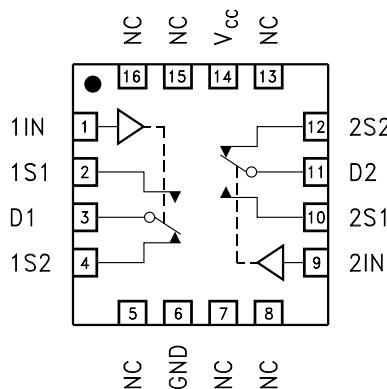


**Table 1: Order Codes**

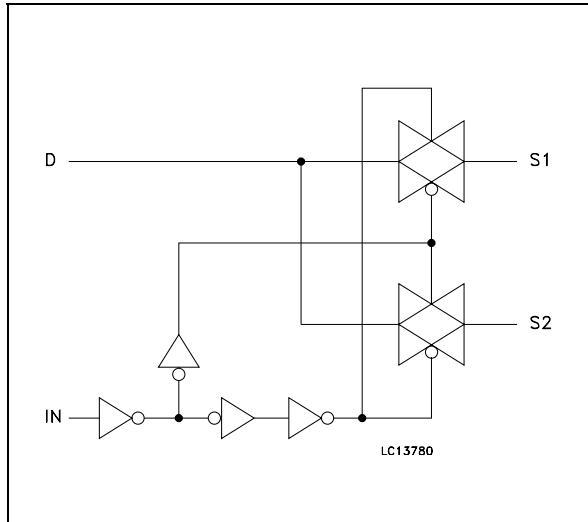
PACKAGE	T & R
QFN	STG3680QTR

the switches. The switches nS1 are ON (they are connected to common Ports Dn) when the nIN input is held high and OFF (high impedance state exists between the two ports) when nIN is held low; the switches nS2 are ON (they are connected to common Ports Dn) when the nIN input is held low and OFF (high impedance state exists between the two ports) when IN is held high. Additional key features are fast switching speed, Break Before Make Delay Time and Ultra Low Power Consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage. It's available in the commercial temperature range in the QFN package.

**Figure 1: Pin Connection**



CS13810

**Figure 2: Input Equivalent Circuit****Table 2: Pin Description**

QFN PIN N°	SYMBOL	NAME AND FUNCTION
1, 9	1IN, 2IN	Controls
2, 10 4, 12	1S1 to 2S1 1S2 to 2S2	Independent Channels
3, 11	D1, D2	Common Channels
5,7,8,13,15,16	NC	Not Connected
6	GND	Ground (0V)
14	Vcc	Positive Supply Voltage

**Table 3: Truth Table**

IN	SWITCH S1	SWITCH S2
H	ON	OFF(*)
L	OFF(*)	ON

(\*) High Impedance

**Table 4: Absolute Maximum Ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	-0.5 to 4.6	V
$V_I$	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
$V_{IC}$	DC Control Input Voltage	-0.5 to 4.6	V
$V_O$	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_{IKC}$	DC Input Diode Current on control pin ( $V_{IN} < 0V$ )	-50	mA
$I_{IK}$	DC Input Diode Current ( $V_{IN} < 0V$ )	$\pm 50$	mA
$I_{OK}$	DC Output Diode Current	$\pm 20$	mA
$I_O$	DC Output Current	$\pm 300$	mA
$I_{OP}$	DC Output Current Peak (pulse at 1ms, 10% duty cycle)	$\pm 500$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current	$\pm 100$	mA
$P_D$	Power Dissipation at $T_a=70^\circ C$ (1)	1120	mW
$T_{stg}$	Storage Temperature	-65 to 150	°C
$T_L$	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

(1) Derate above  $70^\circ C$ : by 18.5mW/°C.

**Table 5: Recommended Operating Conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage (note 1)	1.65 to 4.3	V
$V_I$	Input Voltage	0 to $V_{CC}$	V
$V_{IC}$	Control Input Voltage	0 to 4.3	V
$V_O$	Output Voltage	0 to $V_{CC}$	V
$T_{op}$	Operating Temperature	-55 to 125	°C
$dt/dv$	Input Rise and Fall Time Control Input	$V_{CC}= 1.65V \text{ to } 2.7V$	0 to 20
		$V_{CC}= 3.0V \text{ to } 4.3V$	0 to 10
			ns/V

1) Truth Table guaranteed: 1.2V to 4.3V.

Table 6: DC Specifications

Symbol	Parameter	Test Conditions		Value						Unit		
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25°C			-40 to 85°C		-55 to 125°C			
				Min.	Typ.	Max.	Min.	Max.	Min.			
V <sub>IH</sub>	High Level Input Voltage	1.65-1.95		0.65V <sub>CC</sub>			0.65V <sub>CC</sub>		0.65V <sub>CC</sub>	V		
		2.3-2.5		1.4			1.4		1.4			
		2.7-3.0		1.4			1.4		1.4			
		3.3		1.5			1.5		1.5			
		3.6		1.7			1.7		1.7			
		4.3		2.2			2.2		2.2			
V <sub>IL</sub>	Low Level Input Voltage	1.65-1.95				0.40		0.40		0.40	V	
		2.3-2.5				0.50		0.50		0.50		
		2.7-3.6				0.50		0.50		0.50		
		3.3				0.50		0.50		0.50		
		3.6				0.50		0.50		0.50		
		4.3				1.3		1.3		1.3		
R <sub>ON-S1</sub>	Switch ON-S1 Resistance (1)	4.3	V <sub>S</sub> =0V to V <sub>CC</sub> I <sub>S</sub> =100mA			0.80		0.80			Ω	
		3.0				0.80		0.80				
		2.7				0.80		0.80				
		2.3				2		2				
		1.8				4.0		5.0				
		1.65				4.0		5.0				
R <sub>ON-S2</sub>	Switch ON-S2 Resistance (1)	4.3	V <sub>S</sub> =0V to V <sub>CC</sub> I <sub>S</sub> =100mA		0.40	0.50		0.60			Ω	
		3.0			0.40	0.50		0.60				
		2.7			0.40	0.50		0.60				
		2.3			0.50	0.80		0.80				
		1.8			0.70	3.0		4.0				
		1.65			0.80	3.0		4.0				
ΔR <sub>ON</sub>	ON Resist. Match between channels (1, 2)	2.7	V <sub>S</sub> =1.5V I <sub>S</sub> =100mA		0.06						Ω	
R <sub>FLAT</sub>	ON Resistance FLATNESS (3)	4.3	V <sub>S</sub> =1.5V I <sub>S</sub> =100mA								Ω	
		3.0										
		2.7			0.07	0.15		0.15				
		2.3										
		1.65	V <sub>S</sub> =0.8V I <sub>S</sub> =100mA									
I <sub>OFF</sub>	OFF State Leakage Current (nSn), (Dn)	4.3	V <sub>S</sub> =0.3 or 4V			±10		± 100			nA	
I <sub>IN</sub>	Input Leak. Current	0 - 4.3	V <sub>IN</sub> =0 to 3.6V			±0.1		± 1			μA	
I <sub>CC</sub>	Quiescent Supply Current (1)	1.65-4.3	V <sub>IN</sub> =V <sub>CC</sub> or GND			±0.05		±0.2		±1	μA	

Note 1: Guaranteed by design

Note 2: ΔR<sub>ON</sub> = R<sub>ON(MAX)</sub> - R<sub>ON(MIN)</sub>.

Note 3: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

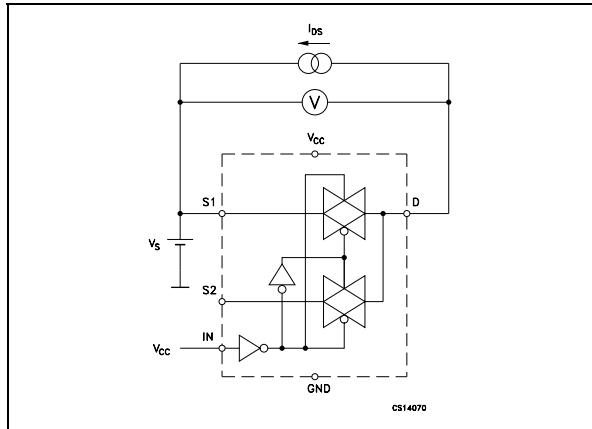
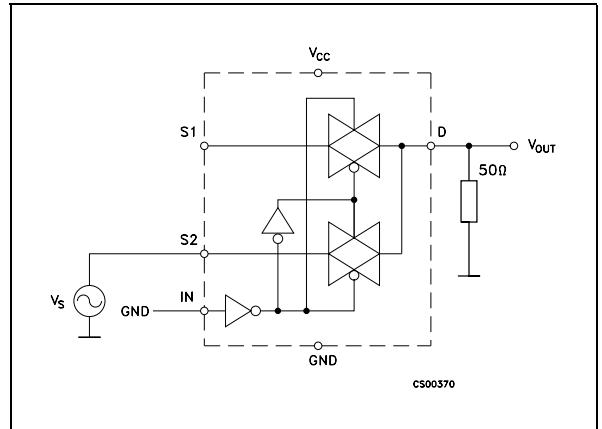
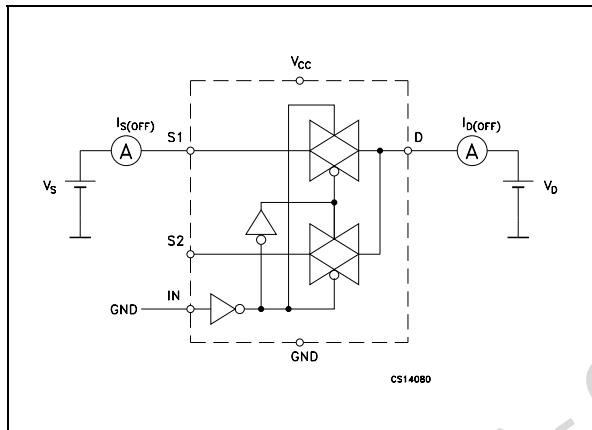
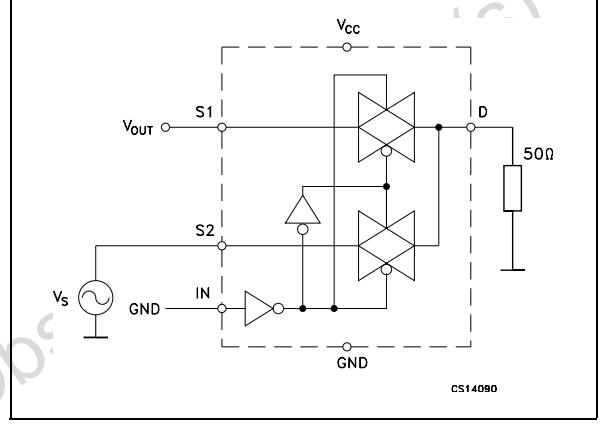
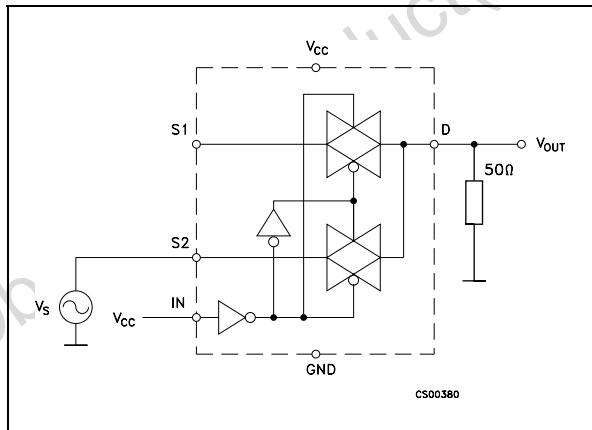
**Table 7: AC Electrical Characteristics ( $C_L = 35\text{pF}$ ,  $R_L = 50\Omega$ ,  $t_r = t_f \leq 5\text{ns}$ )**

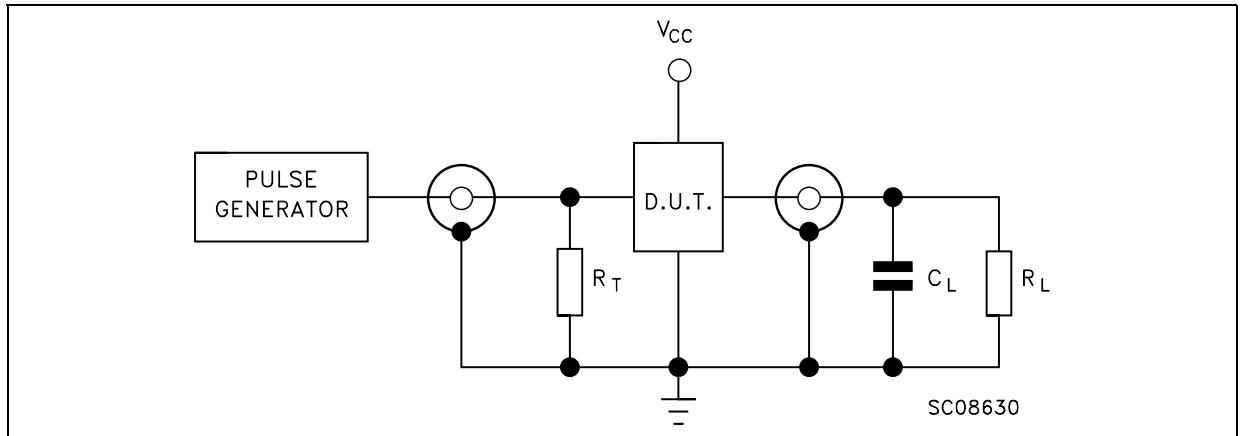
Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$		
				Min.	Typ.	Max.	Min.	Max.	Min.		
$t_{PLH}, t_{PHL}$	Propagation Delay	1.65-1.95	$V_I = \text{OPEN}$		0.45					ns	
		2.3-2.7			0.40						
		3.0-3.6			0.30						
		3.6-4.3			0.30						
$t_{ON}$	TURN-ON time	1.65-1.95	$V_S = 0.8\text{V}$		70					ns	
		2.3-2.7	$V_S = 1.5\text{V}$		30	50		60			
		3.0-3.6	$V_S = 1.5\text{V}$		30	50		60			
		3.6-4.3	$V_S = 1.5\text{V}$		30	50		60			
$t_{OFF}$	TURN-OFF time	1.65-1.95	$V_S = 0.8\text{V}$		45					ns	
		2.3-2.7	$V_S = 1.5\text{V}$		25	30		40			
		3.0-3.6	$V_S = 1.5\text{V}$		25	30		40			
		3.6-4.3	$V_S = 1.5\text{V}$		25	30		40			
$t_D$	Break Before Make Time Delay	1.65-1.95	$C_L = 35\text{pF}$ $R_L = 50\Omega$ $V_S = 1.5\text{V}$							ns	
		2.3-2.7		2	15						
		3.0-3.6		2	15						
		3.6-4.3		2	15						
$Q$	Charge injection	1.65-1.95	$C_L = 100\text{pF}$ $R_L = 1\text{M}\Omega$ $V_{GEN} = 0\text{V}$ $R_{GEN} = 0\Omega$		50					pC	
		2.3-2.7			40						
		3.0-3.6			35						
		3.6-4.3			35						

**Table 8: Analog Switch Characteristics ( $C_L = 5\text{pF}$ ,  $R_L = 50\Omega$ ,  $T_A = 25^\circ\text{C}$ )**

Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$		
				Min.	Typ.	Max.	Min.	Max.	Min.		
OIRR	Off Isolation (1)	1.65-4.3	$V_S = 1\text{V}_{\text{RMS}}$ $f = 100\text{kHz}$		-64					dB	
Xtalk	Crosstalk	1.65-4.3	$V_S = 1\text{V}_{\text{RMS}}$ $f = 100\text{kHz}$		-54					dB	
THD	Total Harmonic Distortion	2.3-4.3	$R_L = 600\Omega$ $V_{IN} = 2\text{V}_{\text{PP}}$ $f = 20\text{Hz to } 20\text{kHz}$		0.03					%	
BW	-3dB Bandwidth	1.65-4.3	$R_L = 50\Omega$		50					MHz	
$C_{IN}$	Control Pin Input Capacitance				5					pF	
$C_{Sn}$	Sn Port Capacitance	3.3	$f = 1\text{MHz}$		37						
$C_D$	D Port Capacitance when Switch is Enabled	3.3	$f = 1\text{MHz}$		84						

Note 1: Off Isolation =  $20\log_{10}(V_D/V_S)$ ,  $V_D$  = output.  $V_S$  = input at off switch

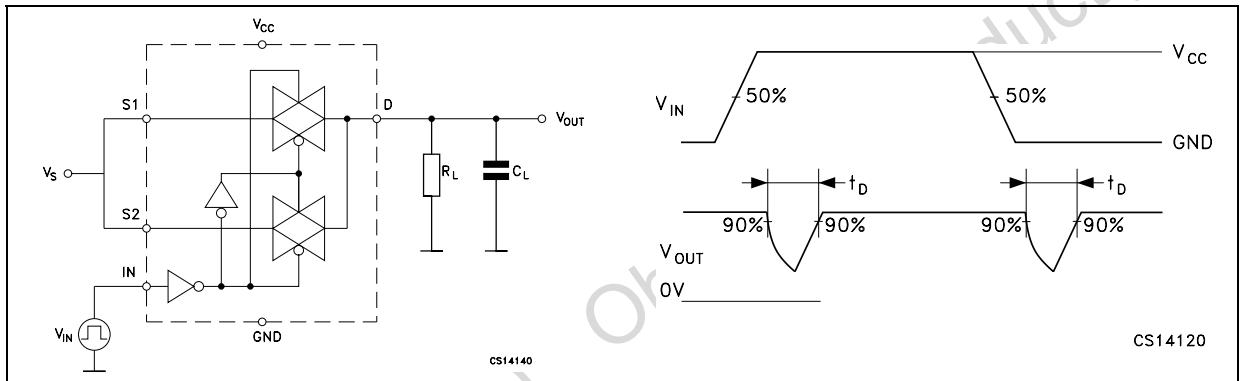
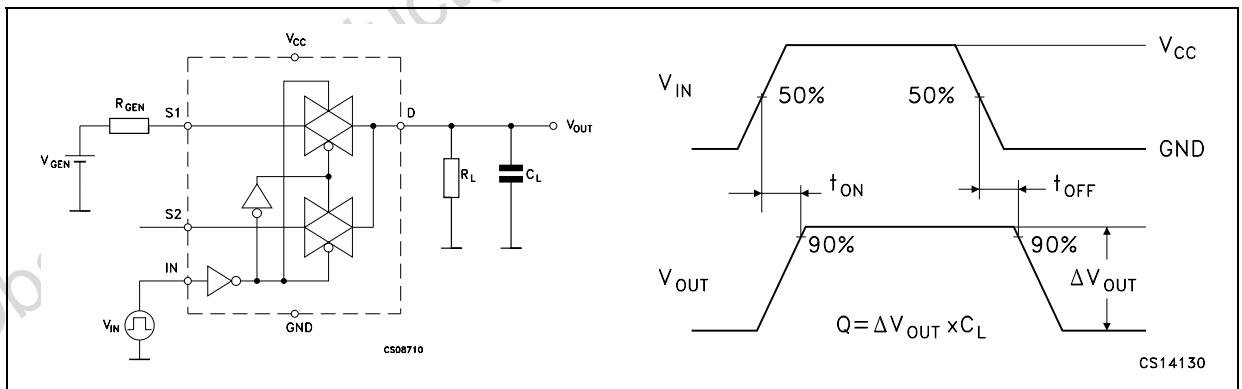
**Figure 3: ON Resistance****Figure 6: Bandwidth****Figure 4: OFF Leakage****Figure 7: Channel To Channel Crosstalk****Figure 5: OFF Isolation**

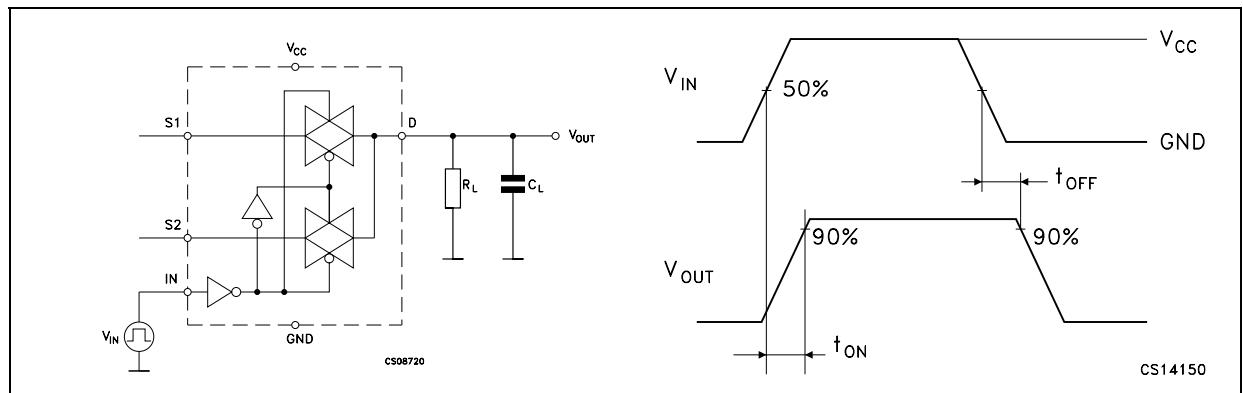
**Figure 8: Test Circuit**

$C_L = 5/35\text{pF}$  or equivalent (includes jig and probe capacitance)

$R_L = 50\Omega$  or equivalent

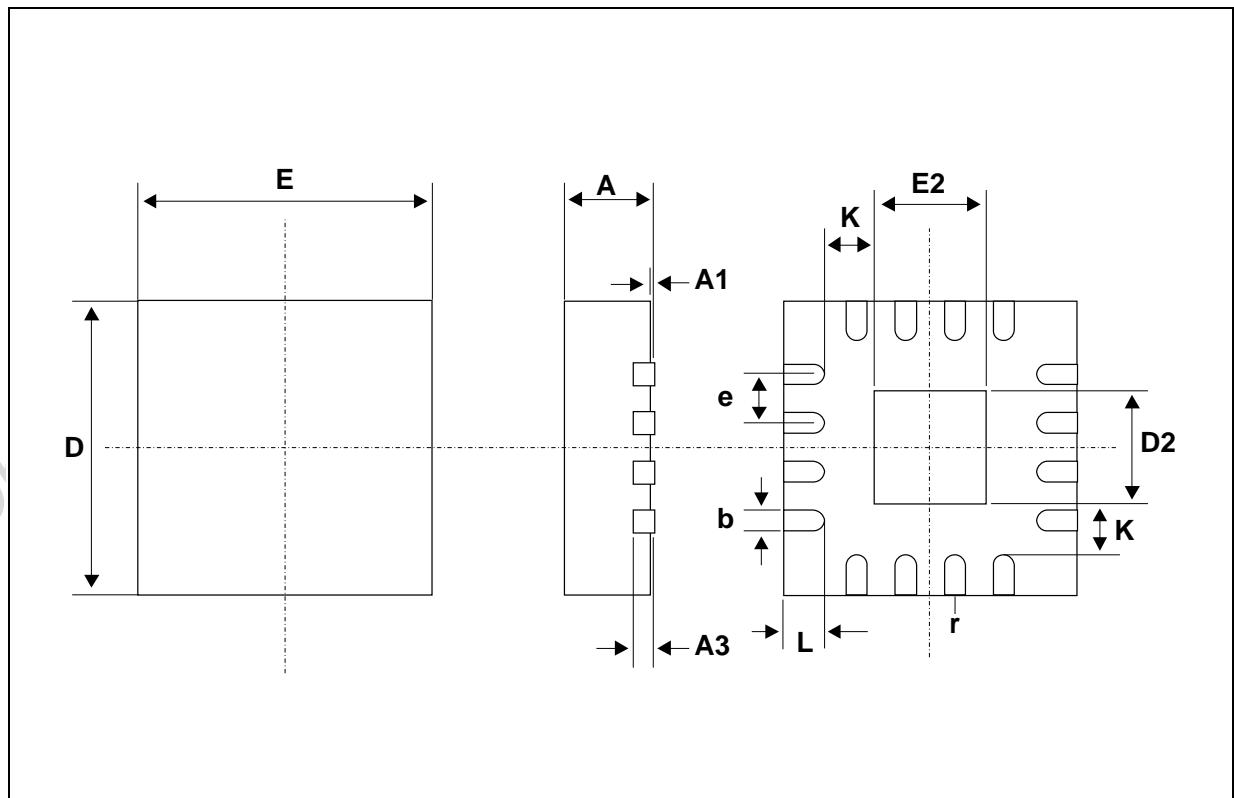
$R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

**Figure 9: Break Before Make Time Delay****Figure 10: Charge Injection ( $V_{GEN}=0V$ ,  $R_{GEN}=0\Omega$ ,  $R_L=1M\Omega$ ,  $C_L=100\text{pF}$ )**

**Table 9: Turn ON, Turn OFF Delay Time**

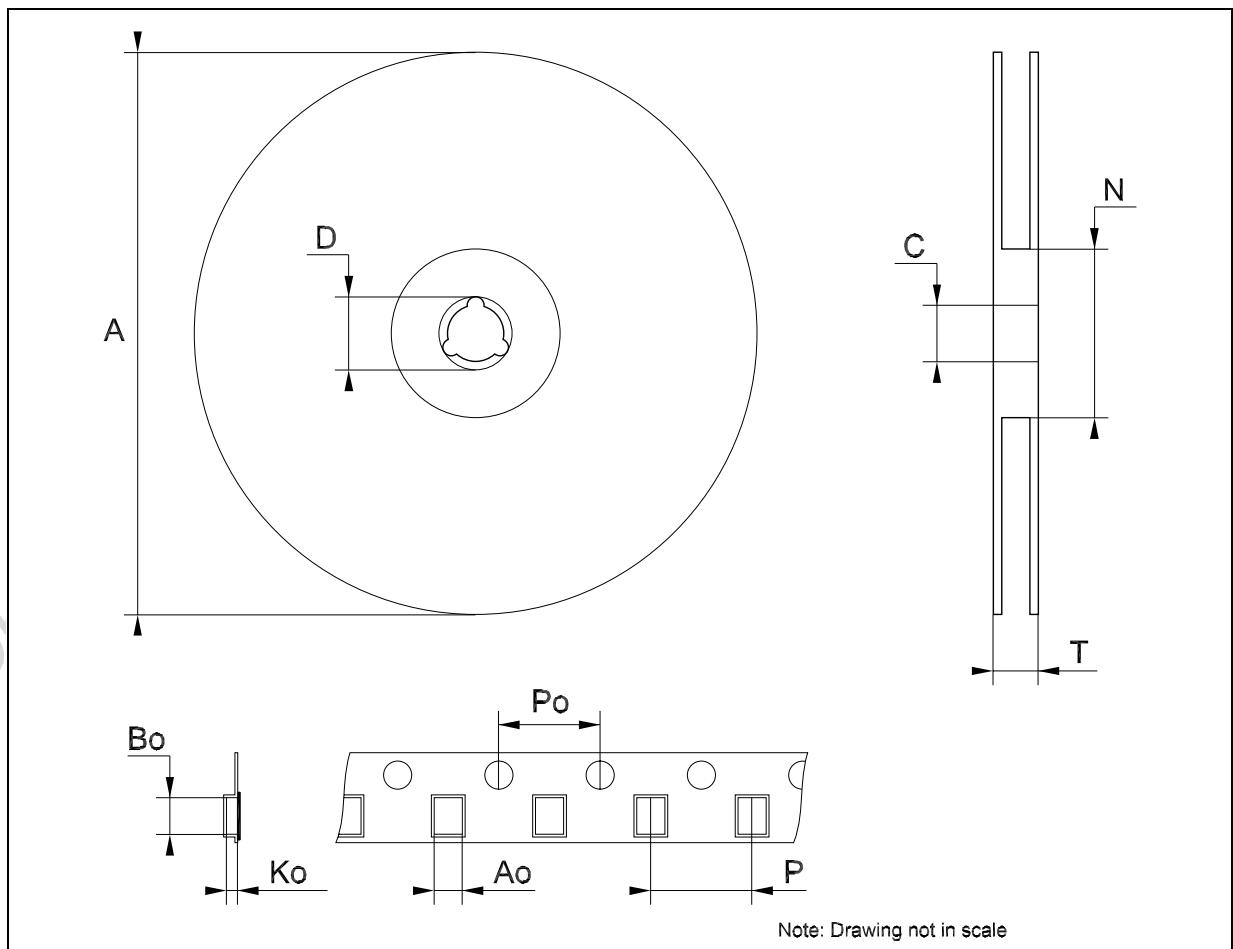
**QFN16 (3x3) MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	0.80	0.90	1.00	0.032	0.035	0.039
A1		0.02	0.05		0.001	0.002
A3		0.20			0.008	
b	0.18	0.25	0.30	0.007	0.010	0.012
D		3.00			0.118	
D2	1.55	1.70	1.80	0.061	0.067	0.071
E		3.00			0.118	
E2	1.55	1.70	1.80	0.061	0.067	0.071
e		0.50			0.020	
K		0.20			0.008	
L	0.30	0.40	0.50	0.012	0.016	0.020
r	0.09			0.006		



## Tape & Reel QFN<sub>xx</sub>/DFN<sub>xx</sub> (3x3) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			18.4			0.724
A <sub>o</sub>		3.3			0.130	
B <sub>o</sub>		3.3			0.130	
K <sub>o</sub>		1.1			0.043	
P <sub>o</sub>		4			0.157	
P		8			0.315	



**Table 10: Revision History**

Date	Revision	Description of Changes
14-May-2004	3	Characteristics at $V_{CC} = 4.3$ V Added on Tables 3, 4, 5, 6 and 7.
01-Jun-2004	4	ESD Performance (Analog Channels) added on top page.
04-Jul-2005	5	The Q Values on Table 7 has been updated.

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

All other names are the property of their respective owners

© 2005 STMicroelectronics - All Rights Reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -  
Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)